



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Prindiville et al.

Art Unit: 2827

Application No.: 09/971,952

CERTIFICATE OF MAILING

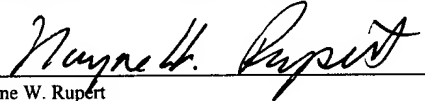
Filed: October 4, 2001

For: SEMICONDUCTOR PACKAGES AND
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Examiner: Lourdes C. Cruz

Date: June 24, 2002

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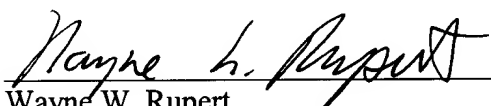
LETTER TO THE OFFICIAL DRAFTSPERSON

Attached are two (2) sheets of formal drawings for this application (sheet 1 of 5 and sheet 4 of 5), with each sheet indicating the title, inventor's name, and application number on the front of each sheet and centered within the top margin.

Please return the enclosed postcard to confirm that the items listed above have been received.

Respectfully submitted,

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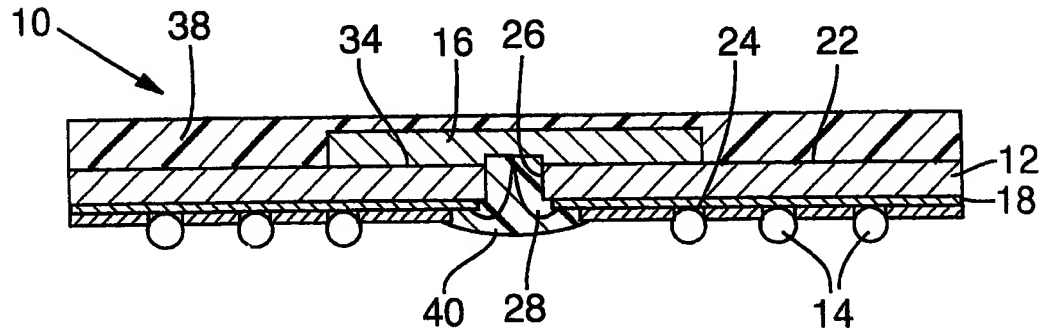


FIG. 1A
(PRIOR ART)

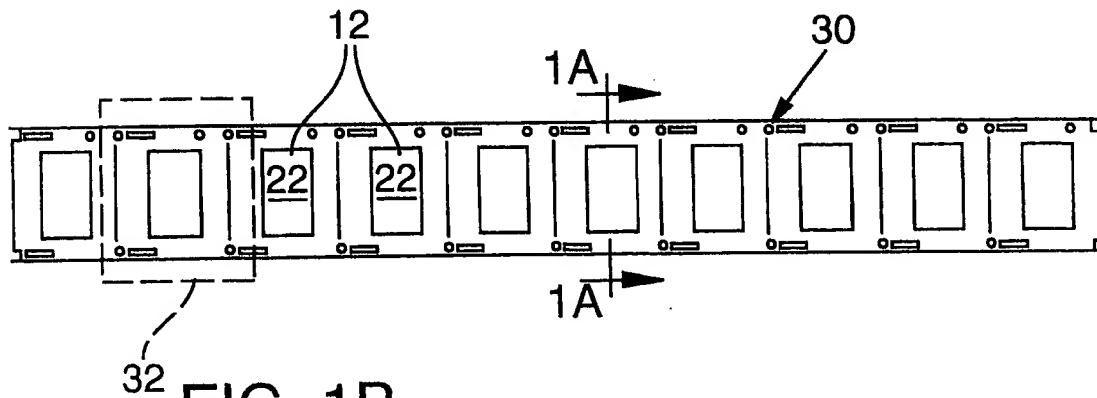


FIG. 1B
(PRIOR ART)

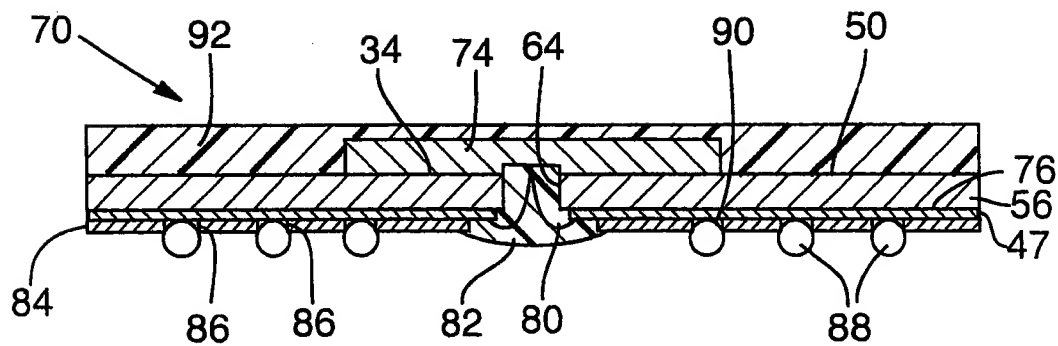


FIG. 3A

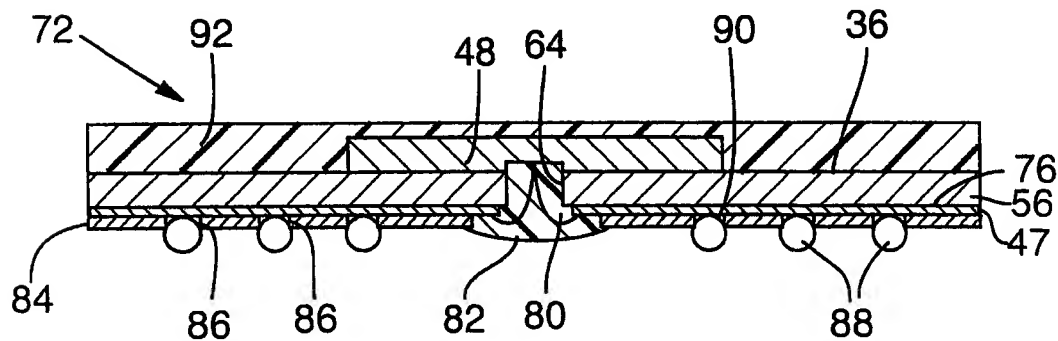


FIG. 3B